General Description

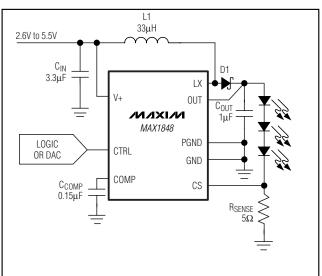
The MAX1848 drives white LEDs with a constant current to provide backlight in cell phones, PDAs, and other hand-held devices. The step-up converter topology allows series connection of the white LEDs so that the LED currents are identical for uniform brightness. This configuration eliminates the need for ballast resistors and expensive factory calibration. Other benefits include greater simplicity, lower cost, higher efficiency, and greater reliability.

This step-up PWM converter includes an internal, highvoltage, low RDSON N-channel MOSFET switch for high efficiency and maximum battery life. A single analog voltage Dual Mode[™] input provides a simple means of brightness adjustment and on/off control. Fast 1.2MHz current-mode PWM control allows for small input and output capacitors and a small inductor while minimizing ripple on the input supply/battery. Programmable softstart eliminates inrush current during startup.

The MAX1848 is available in a space-saving, 8-pin SOT23 package.

Applications

Cell Phones and Smart Phones PDAs. Palmtops, and Wireless Handhelds e-Books and Subnotebooks White LED Display Backlighting



Typical Application Circuit

1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

MIXIM

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at

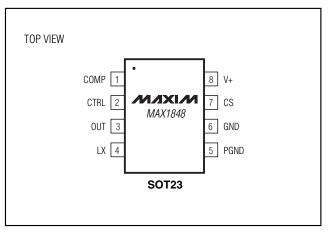
- Constant Current Regulation for Uniform Illumination
- High 87% Efficiency
- Analog or Logic Control of LED Intensity
- 0.8W Output Power with Internal High-Voltage **MOSFET Switch**
- Small, Low-Profile External Components
- 2.6V to 5.5V Input Range
- 13V Maximum Output with Overvoltage Protection
- Optimized for Low Input Ripple
- Programmable Soft-Start
- O.3µA Shutdown Current
- Small 8-Pin SOT23 Package

Ordering Information

PART	TEMP.	PIN-	TOP
	RANGE	PACKAGE	MARK
MAX1848EKA	-40°C to +85°C	8 SOT23	AAIM

Note: The MAX1848 requires a special solder temperature profile described in the Absolute Maximum Ratings section.

Pin Configuration



Dual Mode is a trademark of Maxim Integrated Products, Inc.

ABSOLUTE MAXIMUM RATINGS

PGND to GND LX, OUT to GND LX to OUT CTRL to GND COMP, CS to GND	-0.3V to +6.0V -0.3V to +0.3V -0.3V to +14V -14V to +0.3V -0.3V to +6.0V or (V+ + 2V) -0.3V to (V+ + 0.3V) 0.3V to (V+ + 0.3V)	Continuous Power Dissipation (T _A = +70° 8-Pin SOT23 (derate 9.7mW/°C above + Operating Temperature Range Junction Temperature Storage Temperature Range Lead Temperature.	-70°C)777mW 40°C to +85°C +150°C 60°C to +150°C
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Note 1: This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board-level solder attach and rework. Maxim recommends the use of the solder profiles recommended in the industry-standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow processes. Preheating, per this standard, is required. Hand or wave soldering is not recommended.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V+ = 3.0V, V_{OUT} = 11V, L = 33\mu$ H, $C_{OUT} = 1\mu$ F, $C_{COMP} = 0.15\mu$ F, $R_{SENSE} = 5\Omega$, $V_{CTRL} = 1V$, $T_A = 0^{\circ}$ C to +85°C, unless otherwise noted. Typical values are at $T_A = +25^{\circ}$ C.)

PARAMETER	C	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Voltage			2.6		5.5	V
	V+ rising, 40mV hysteresis typical		2.15	2.38	2.59	
Undervoltage Lockout Threshold	V+ falling		2.10	2.34	2.56	V
	Not switching, $V_{CTRL} = V_{CS} = V_{+}$			0.25	0.40	mA
Quiescent Current	Switching, VCTRL = V	Switching, $V_{CTRL} = V_+$, $V_{CS} = GND$		1	2	
		T _A = +25°C		0.3	1	μΑ
Shutdown Supply Current	$V_{CTRL} = GND$	$T_A = +85^{\circ}C$		0.3		
	V+ rising, 1V hystere	sis typical	12.5	13.25	14.0	V
Overvoltage Threshold	V+ falling		11.5	12.25	13	
	101/	V _{CTRL} > 0.25V	10	20	30	μA
OUT Input Bias Current	$V_{OUT} = 13V$	V _{CTRL} = GND		0.01	1	
Output Voltage Range			V+ - Vdiode		12.5	V
ERROR AMPLIFIER						
CTRL to CS Regulation	V _{CTRL} = 2.0V, V+ = 2.6V to 5.5V		71	75	81	mV/V
CS Input Bias Current	V _{CS} = V _{CTRL} /13.33			0.01	1	μA
CTRL Input Resistance			450	670	1100	kΩ
CTRL Dual-Mode Threshold	Hysteresis = 25mV ty	rpical	100	170	240	mV
CS Line Regulation	V+ = 2.6V to 5.5V, V(CTRL = 3.0V		0.05		%/V
COMP Pin Resistance to Ground	Device in shutdown o	Device in shutdown or overvoltage		15	50	kΩ
COMP Output Voltage Swing			0.3		2.4	V
OSCILLATOR			•			•
Operating Frequency			1	1.2	1.5	MHz
Minimum Duty Cycle	PWM mode			12		
	Pulse skipping			0		%
Maximum Duty Cycle	$V_{CTRL} = V_+, V_{CS} = GND$		85	90	97	%

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V + = 3.0V, V_{OUT} = 11V, L = 33\mu$ H, $C_{OUT} = 1\mu$ F, $C_{COMP} = 0.15\mu$ F, $R_{SENSE} = 5\Omega$, $V_{CTRL} = 1V$, $T_A = 0^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A = +25^{\circ}$ C.)

PARAMETER	CC	CONDITIONS		ТҮР	MAX	UNITS
N-CHANNEL SWITCH						
LX On-Resistance	$I_{LX} = 100 \text{mA}$	I _{LX} = 100mA		1.4	2.2	Ω
LX Leakage Current		$T_A = +25^{\circ}C$		0.01	2	
	$V_{OUT} = V_{LX} = 13V$	T _A = +85°C		0.05		μA
LX Current Limit	Duty cycle = 65%	÷	250	500	750	mA

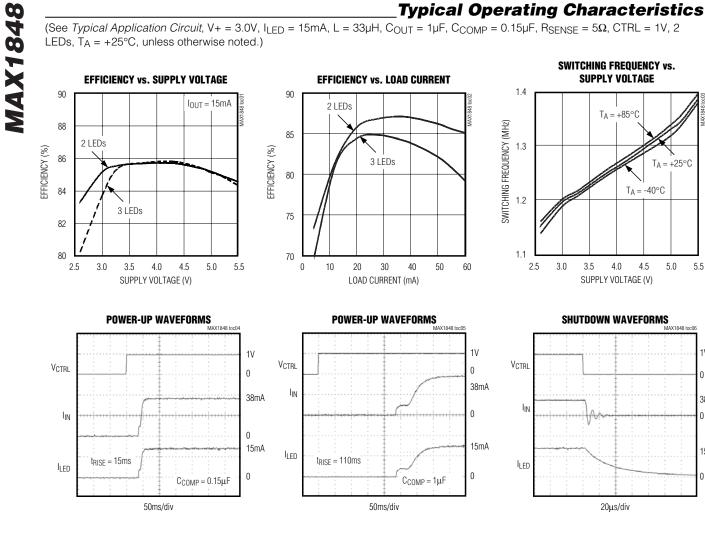
DC ELECTRICAL CHARACTERISTICS

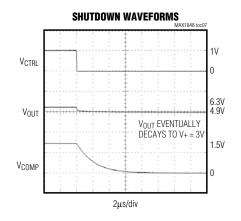
 $(V+=3.0V, V_{OUT}=11V, L=33\mu H, C_{OUT}=1\mu F, C_{COMP}=0.15\mu F, R_{SENSE}=5\Omega, V_{CTRL}=1V, \textbf{T}_{\textbf{A}}=\textbf{-40^{\circ}C to +85^{\circ}C}, unless otherwise noted. (Note 2)$

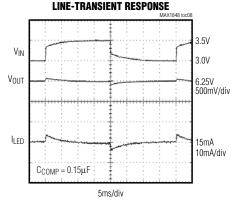
PARAMETER	CONDITIONS		MIN	MAX	UNITS
Supply Voltage			2.6	5.5	V
	V+ rising, 40mV hysteresis typical		2.15	2.59	
Undervoltage Lockout Threshold	V+ falling		2.1	2.56	- V
	Not switching, $V_{CTRL} = V_{CS} = V_{+}$			0.4	
Quiescent Current	Switching, V _{CTRL} = V	Switching, $V_{CTRL} = V_+$, $V_{CS} = GND$		2	mA
	V+ rising, 1V hysteres	sis typical	12.25	14	
Overvoltage Threshold	V+ falling		11.25	13.25	V
		V _{CTRL} > 0.25V	10	30	1.
OUT Input Bias Current	$V_{OUT} = 13V$	V _{CTRL} = GND		1	μA
Output Voltage Range			V+ - Vdiode	12.25	V
ERROR AMPLIFIER					
CTRL to CS Regulation	V _{CTRL} = 2.0V, V+ = 2	.6V to 5.5V	65	85	mV/V
CS Input Bias Current	V _{CS} = V _{CTRL} /13.33			1	μΑ
CTRL Input Resistance			450	1100	kΩ
CTRL Dual-Mode Threshold	Hysteresis = 25mV typical		100	240	mV
COMP Pin Resistance to Ground	Device in shutdown or overvoltage		7.5	50	kΩ
COMP Output Voltage Swing			0.3	2.4	V
OSCILLATOR					
Operating Frequency			0.9	1.6	MHz
Maximum Duty Cycle	$V_{CTRL} = V+, V_{CS} = GND$		85	97	%
N-CHANNEL SWITCH					
LX On-Resistance	$I_{LX} = 100 mA$			2.2	Ω
LX Current Limit	Duty cycle = 65%		200	900	mA

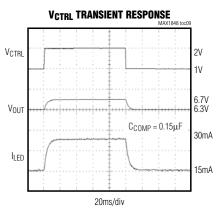
Note 2: Limits are 100% production tested at $T_A = +25$ °C. Limits over the operating temperature range are guaranteed through correlation using statistical quality control (SQC) methods.



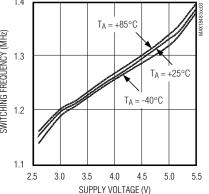




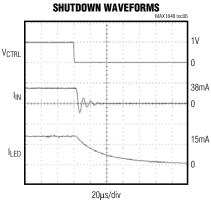




SWITCHING FREQUENCY vs. SUPPLY VOLTAGE

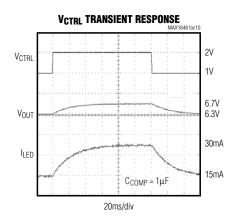


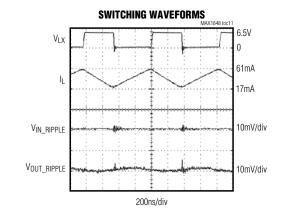




Typical Operating Characteristics (continued)

(See *Typical Application Circuit*, V+ = 3.0V, I_{LED} = 15mA, L = 33µH, C_{OUT} = 1µF, C_{COMP} = 0.15µF, R_{SENSE} = 5 Ω , CTRL = 1V, 2 LEDs, T_A = +25°C, unless otherwise noted.)





Pin Description

PIN	NAME	FUNCTION
1	COMP	Compensation Pin for Error Amplifier. Connect capacitor from COMP to GND. Startup time is set by the capacitance connected to this pin (0.833ms for each 0.01 μ F). V _{COMP} passively discharges to GND when in shutdown.
2	CTRL	Brightness/Shutdown Dual-Mode Control Input. LED brightness and IC shutdown are controlled by the voltage on CTRL. Voltages between 250mV and 5.5V or (V+ + 2V), whichever is less, adjust the brightness from dim to bright, respectively. To put the IC into shutdown, drive below 100mV or connect to GND.
3	OUT	Overvoltage Sense. When V _{OUT} is greater than 13.25V, the internal N-channel MOSFET is turned off and V _{COMP} decays to GND. When V _{OUT} drops below 12.25V, the IC will re-enter soft-start. Connect a 1 μ F capacitor from OUT to GND.
4	LX	Inductor Connection. Drain of the internal high-voltage N-channel MOSFET.
5	PGND	Power Ground. Source of the internal high-voltage N-channel MOSFET.
6	GND	Ground
7	CS	Current-Sense Feedback Input. Connect a resistor from this pin to GND to set the LED bias current. This pin regulates to 7.5% of V_{CTRL} .
8	V+	Supply Voltage Input. The IC is powered from this pin. Input range is 2.6V to 5.5V. Bypass with a ceramic capacitor to GND.

_Detailed Description

The MAX1848's high efficiency and small size make it ideally suited to drive series-connected LEDs. It operates as a boost DC-DC converter that controls output current rather than voltage. The MAX1848 provides even illumination by sending the same output current through each LED, eliminating the need for expensive factory calibration. The fast 1.2MHz internal oscillator allows for a small inductor and small input and output capacitors while minimizing input and output ripple.

The single analog control input allows easy adjustment of LED brightness and on/off control. This allows either simple logic-level on/off control or a DAC to control both brightness and on/off. In shutdown, supply current is reduced to a low 0.3μ A. A programmable soft-start gradually illuminates the LEDs, reducing the inrush current during startup.

Soft-Start

The MAX1848 attains soft-start by charging C_{COMP} gradually with a constant 12μ A current. When V_{COMP} rises above 1.25V, the internal MOSFET begins switching, but at a reduced duty cycle. When V_{COMP} rises above 2.25V, the duty cycle will be at its maximum.

The maximum startup time is determined by the value of C_COMP. For every 0.01 μF connected to COMP, the

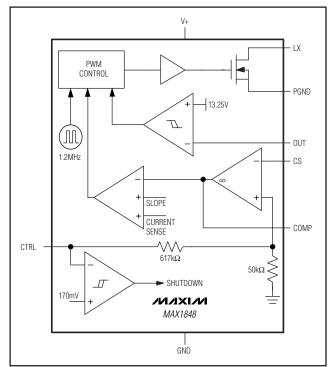


Figure 1. Functional Diagram

startup time will increase by 0.833ms. The start time can be calculated by:

$$t_{\text{SOFT-START (MAX)}} = C_{\text{COMP}} \times \frac{1V}{12\mu\text{A}}$$

Shutdown

The MAX1848 is put into shutdown when V_{CTRL} is less than 100mV. In shutdown, supply current is reduced to 0.3µA by powering down the entire IC except for the CTRL voltage detection circuitry. C_{COMP} is passively discharged during shutdown, allowing the device to reinitiate a soft-start whenever the device is enabled.

When in shutdown, the internal N-channel FET does not switch, which leaves a current path between the input and the LEDs through the boost inductor and Schottky diode. The minimum forward voltage of the LED array must exceed the maximum V+ to ensure that the LEDs remain off in shutdown. Typical shutdown timing characteristics are shown in the *Typical Operating Characteristics*.

Overvoltage Protection

Overvoltage protection occurs when V_{OUT} is above 13.25V. The protection circuitry stops the internal MOS-FET from switching and causes V_{COMP} to decay to GND. The device comes out of overvoltage lockout and into soft-start when V_{OUT} falls below 12.25V.

Design Procedure

Adjusting LED Current

Adjusting the MAX1848's output current will change the brightness of the LEDs. An analog input (CTRL) and the sense resistor value set the output current. Output current is given by:

$$I_{LED} = \frac{V_{CTRL}}{13.33 \times R_{SENSE}}$$

The V_{CTRL} voltage range for adjusting output current is 250mV to (V+ + 2V) or 5.5V, whichever is less. To set the maximum current, calculate RSENSE when V_{CTRL} is at its maximum. Power dissipation in RSENSE is typically less than 5mW; therefore, a standard chip resistor is sufficient.

Capacitor Selection

The exact values of input and output capacitors are not critical. The typical value for the input capacitor is 3.3μ F, and the typical value for the output capacitor is 1.0μ F. Larger value capacitors can be used to reduce input and output ripple, but at the expense of size and higher cost.



The output current and the number of LEDs in each leg affect the capacitance of C_{COMP} . Table 1 shows the minimum C_{COMP} values needed to stabilize the converter in worst-case conditions. If further stability analysis is required, note that the error amplifier has 50μ A/V transconductance.

Inductor Selection

The value of the inductor depends on the maximum output current to the LEDs. See Table 1 for inductance values and peak current ratings for the inductor.

Schottky Diode Selection

The MAX1848's high-switching frequency demands a high-speed rectification diode. A Schottky diode is required due to their fast recovery time and low for-ward-voltage drop. Ensure that the diode's average and peak current rating exceed the average output current and peak inductor current, respectively. In addition, the diode's reverse breakdown voltage must exceed V_{OUT}.

 $I_{\text{DIODE}(\text{RMS})} \cong \sqrt{I_{\text{OUT}} \times I_{\text{PEAK}}}$

Applications Information

Connecting Four or Six LEDs

The MAX1848 can drive one, two, or three legs of LEDs (Figure 2) as long as the total number of LEDs does not exceed six. Each leg must contain the same number of LEDs and the same sense-resistor value. Adding the second or third leg does not affect the sense-resistor value (see *Adjusting LED Current*).

Three legs of two LEDs is more efficient than two legs of three LEDs (see Efficiency Graphs in *Typical Operating Characteristics*); however, a third sense resistor is needed. Multiple legs can have slight current mismatches due to component tolerances.

ILED	NO. OF	Ссомр	INDUCTOR		
(mA)	LEDs	(μF)	L (µH)	I _{PEAK} (mA)	
12	3	0.220	FC	80	
12	2	0.100	56	80	
20	3	0.150	- 33	130	
20	2	0.068		130	
40	3	0.100	15	260	
40	2	0.047	15		
60	3	0.068	10	375	
60	2	0.01	10	375	

Table 1. Component Selection

PC Board Layout

Due to fast-switching waveforms and high-current paths, careful PC board layout is required. Protoboards and wire-wrap boards should not be used for evaluation. An evaluation kit (MAX1848EV kit) is available to aid design.

When laying out a board, minimize trace lengths between the IC and R_{SENSE}, the inductor, the diode, the input capacitor, and the output capacitor. Keep traces short, direct, and wide. Keep noisy traces, such as the inductor's traces, away from CS. V+'s bypass capacitor (C_{IN}) should be placed as close to the IC as possible. PGND and GND should be connected in only one place as close to the IC as possible. The ground connections of C_{IN} and C_{OUT} should be as close together as possible. The traces from V+ to the inductor and from the Schottky diode to the LEDs may be longer.

Refer to the MAX1848 EV kit for an example of proper layout.

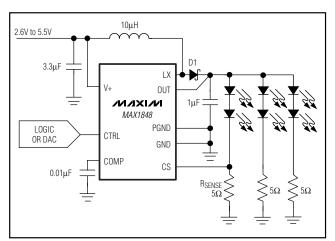
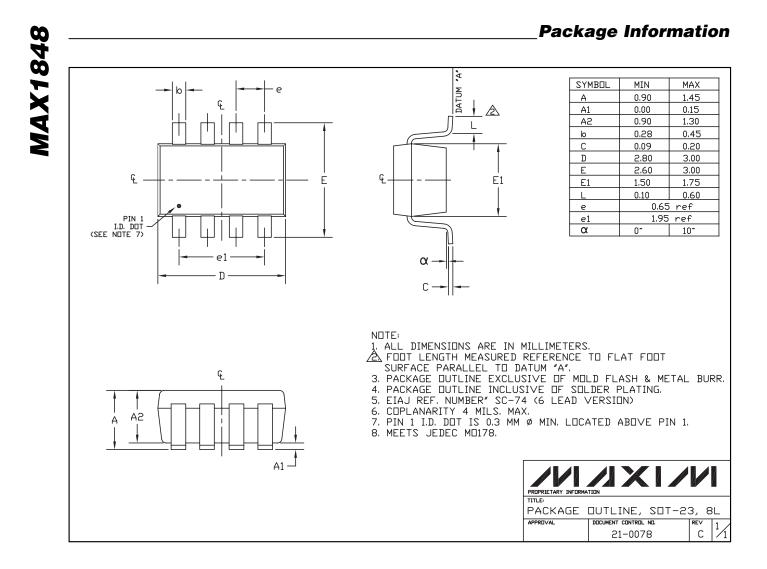


Figure 2. Six LEDs in 3 x 2 Configuration

Chip Information

TRANSISTOR COUNT: 1290



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